

NSF080120L3A0-VB Datasheet N-Channel 1200 V(D-S) SiC Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	1200			
R _{DS(on)} at 25 °C (Ω)	V _{GS} = 18 V	0.08		
Q _g (nC)	110			

FEATURES

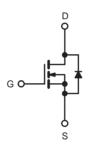
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Qa)
- Avalanche energy rated (UIS)

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- DC/DC converter







N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	1200	V	
Gate-Source Voltage			V_{GS}	-10 / +22	v	
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 18 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	- I _D	30	A	
		T _C = 100 °C		21		
Pulsed Drain Current ^a			I _{DM}	90		
Linear Derating Factor				2.1	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	1200	mJ	
Maximum Power Dissipation			P_{D}	320	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +175	°C	
Drain-Source Voltage Slope	T _J = 125 °C		dV/dt	50	V/ns	
Reverse Diode dV/dt ^d			αν/αι	15	V/IIS	
Soldering Recommendations (Peak Temperature) c	Recommendations (Peak Temperature) c for 10 s			260	°C	

- a. Repetitive rating; pulse width limited by maximum junction temperature. b. $V_{DD}=100$ V, starting $T_{J}=25$ °C, L = 30mH, $R_{g}=25$ Ω , $I_{AS}=9$ A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, dI/dt = 100 A/ μ s, starting $T_J = 25$ °C.



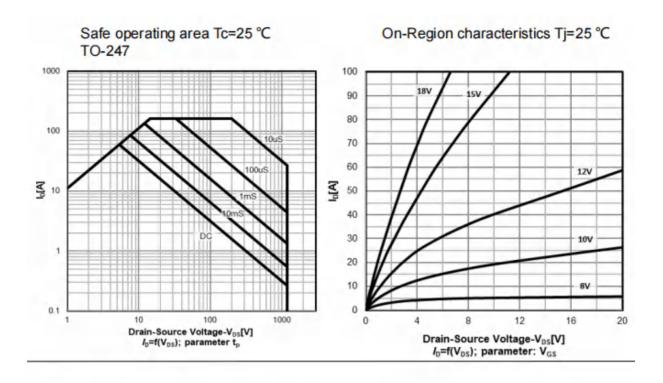
THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R _{thJA}	·	40	°C/W		
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.47	C/VV		

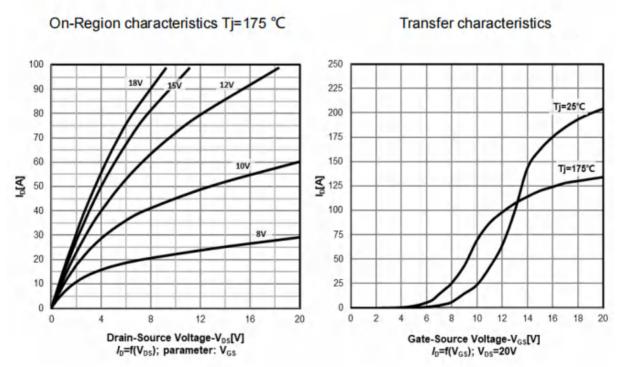
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static						,	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 1 mA	1200	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.70	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}$, $I_D = 10 \text{ mA}$		-	4.5	V
	_	V _{GS} = +22 V		-	_	100	nA
Gate-Source Leakage	I _{GSS}	,	V _{GS} = -10 V		_	100	μΑ
			= 960V, V _{GS} = 0 V	_	10	-	μA
Zero Gate Voltage Drain Current	I_{DSS}	20	/, V _{GS} = 0 V, T _J = 125 °C	-	-	100	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 18 V	I _D = 30A	-	0.08	-	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 0 V, I _D = 30 A	-	16	-	S
Dynamic		<u>'</u>					
Input Capacitance	C _{iss}		V _{GS} = 0 V,	-	3000	-	
Output Capacitance	C _{oss}	1	$V_{DS} = 800 V,$	-	123	-	
Reverse Transfer Capacitance	C _{rss}	1	f = 1 MHz		10	-	pF
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V 0.V/1- 000.V V 0.V		-	156	-	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	V _{DS} = 0 V	$V_{DS} = 0 \text{ V to } 800 \text{ V}, V_{GS} = 0 \text{ V}$		268	-	
Total Gate Charge	Qg		V _{GS} = -5/18 V I _D = 20 A, V _{DS} = 800 V		101	-	nC
Gate-Source Charge	Q _{gs}	V _{GS} = -5/18 V			29	-	
Gate-Drain Charge	Q _{gd}	1	•	-	33	-	7
Turn-On Delay Time	t _{d(on)}	V_{DD} = 800 V, I_{D} = 20A, V_{GS} = -5/18 V , R_{g} = 2 Ω		-	18	25	ns
Rise Time	t _r			-	24	55	
Turn-Off Delay Time	t _{d(off)}			-	80	-	
Fall Time	t _f			-	12	-	
Gate Input Resistance	R_{g}	f = 1 MHz, open drain		-	3.2	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	30	
Pulsed Diode Forward Current	I _{SM}			-	-	90	A A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 30 A, V _{GS} = 0		-	-	4.1	V
Reverse Recovery Time	t _{rr}		., 25 5, 5 = 557, 7, 7, 7, 7		75	-	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 30 \text{ A},$ $dI/dt = 1000 \text{ A/µs}, V_R = 800 \text{ V}$		-	220	-	μC
Reverse Recovery Current	I _{RRM}			_	60	_	A

Notes

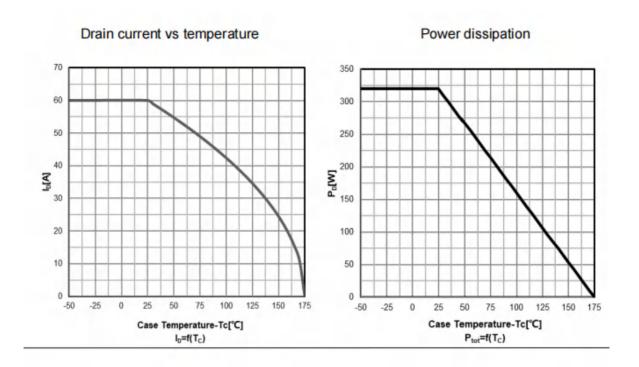
- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

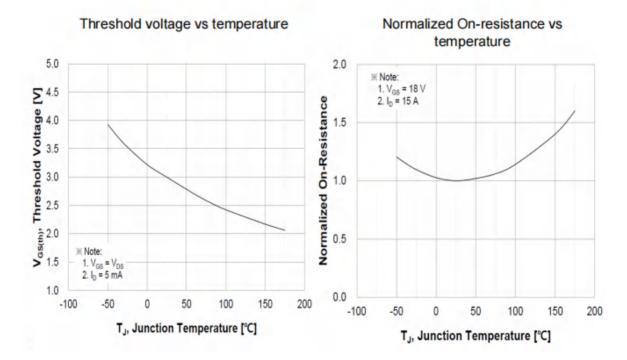




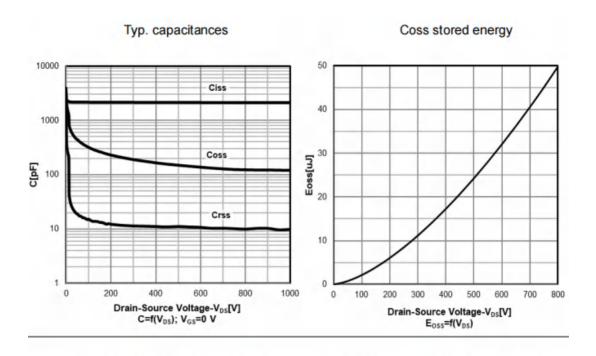


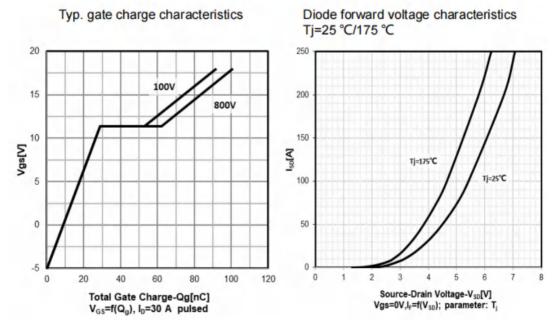








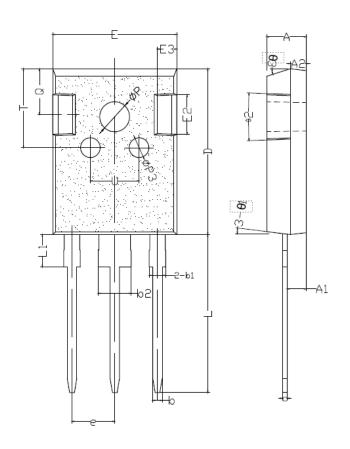


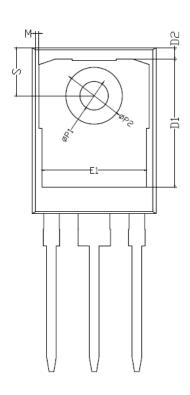


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TO-247 PACKAGE OUTLINE DIMENSIONS







SYMBOL	mm			
	MIN	NOM	MAX	
*A	4.90	5.00	5.10	
*A1	2.31	2.41	2.51	
A2	1.90	2.00	2.10	
*b	1.15	1.20	1.25	
*b1	1.95	2.10	2.25	
*b2	2.95	3.10	3.25	
*c	0.55	0.60	0.65	
*D	20.90	21.00	21.10	
D1	16.35	16.55	16.75	
D2	1.05	1.20	1.35	



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